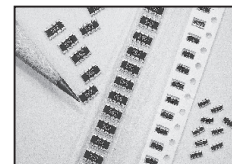


**FEATURES**

- ULTRA MINIATURE SIZE AND LOW PROFILE
- THICK FILM CONSTRUCTION
- HIGH DENSITY PACKAGING OFFERS SIGNIFICANT SPACE SAVINGS
- REFLOW SOLDERING COMPATIBLE



**SPECIFICATIONS**

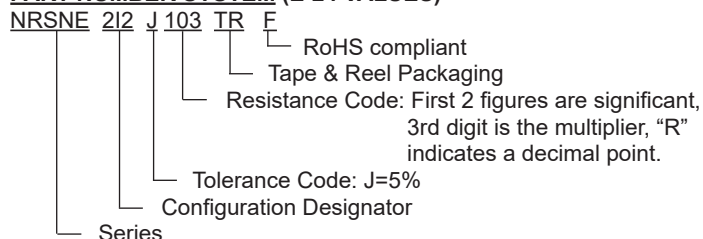
Type	NRSNE212			NRSNE214	
Termination Type	Flat			Flat	
Size W x L (mm)	0.6 x 0.8			0.6 x 1.4	
No. of Resistors & Circuit	2R Isolated			4R Isolated	
Power Rating per Resistor @ +70°C	1/32 (.031W)			1/32 (.031W)	
Resistance Tolerance*	F (±1%)	J (±5%)		F (±1%)	J (±5%)
Resistance Range	10Ω ~ 1MΩ	3.0Ω ~ 9.1Ω	10Ω ~ 1MΩ	10Ω ~ 1MΩ	10Ω ~ 1MΩ
	0Ω (<50mΩ) 0.5A			0Ω (<50mΩ) 0.5A	
Temperature Coefficient	±200ppm	±300ppm	±200ppm	±200ppm	±200ppm
Maximum Working Voltage*	12.5V				
Maximum Overload Voltage**	25V				
Operating Temperature Range	-55°C ~ +125°C				

Type	NRSNE412		NRSNE414		NRSNE614	
Termination Type	Flat		Flat		Flat	
Size W x L (mm)	1.0 x 1.2		1.0 x 2.0		1.55 x 3.2	
No. of Resistors & Circuit	2R Isolated		4R Isolated		4R Isolated	
Power Rating per Resistor @ +70°C	1/16 (.0625W)		1/16 (0.0625W)		1/8 (0.125W)	
Resistance Tolerance*	F (±1%)	J (±5%)	F (±1%)	J (±5%)	F (±1%)	J (±5%)
Resistance Range	1.0Ω ~ 1MΩ		10Ω ~ 1MΩ	1.0Ω ~ 10MΩ	10Ω ~ 1MΩ	1.0Ω ~ 10MΩ
	0Ω (<50mΩ) 1A		0Ω (<50mΩ) 1A		0Ω (<50mΩ) 1A	
Temperature Coefficient	±200ppm		±200ppm		±200ppm	
Maximum Working Voltage*	25V		50V		50V	
Maximum Overload Voltage**	50V		100V		100V	
Operating Temperature Range	-55°C ~ +155°C		-55°C ~ +155°C		-55°C ~ +155°C	

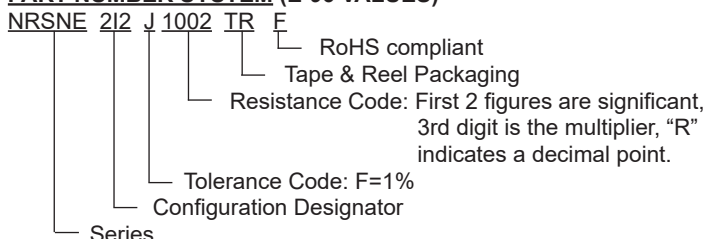
\* Maximum allowable continuous voltage for all resistors is the lower of the two values: "MAXIMUM WORKING VOLTAGE" as specified, or  $\sqrt{\text{Power rating (WATTS)} \times \text{Resistance (OHMS)}}$

\*\* Maximum overload voltage is 2.5x rated voltage based on calculation referenced above or maximum overload voltage as specified in specifications table, whichever is lower.

**PART NUMBER SYSTEM (E-24 VALUES)**

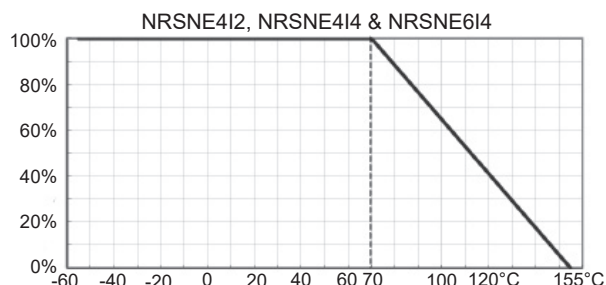
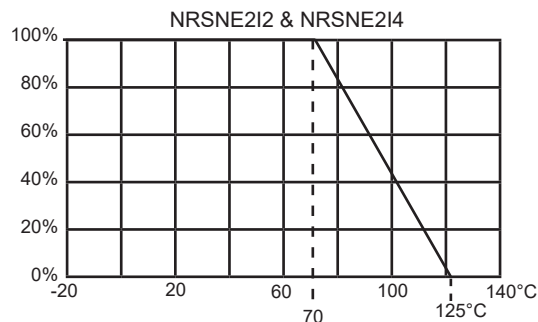


**PART NUMBER SYSTEM (E-96 VALUES)**



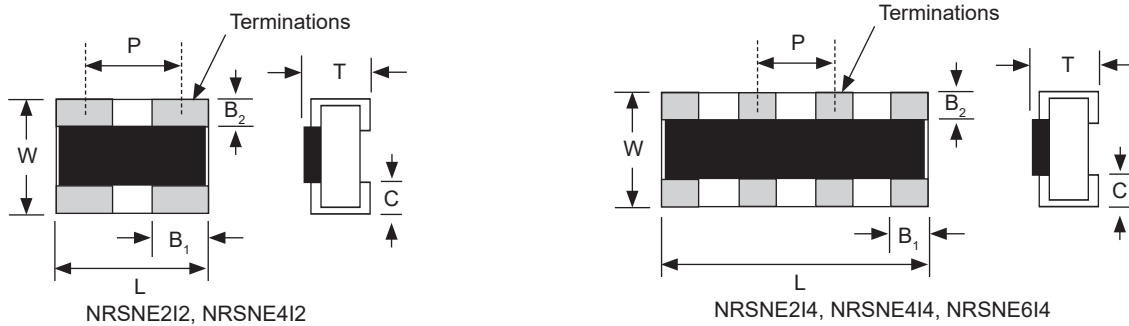
**Power Derating Curve:**

For operation above 70°C, power rating must be derated according to the following chart:



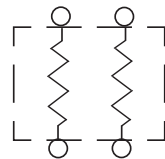
**COMPONENT DIMENSIONS (mm)**

Type	W	L	P	T	B <sub>1</sub>	B <sub>2</sub>	C
NRSNE2I2	0.60 ± 0.10	0.80 ± 0.10	0.50 ± 0.10	0.35 ± 0.10	0.30 ± 0.10	0.15 ± 0.10	0.15 ± 0.10
NRSNE2I4	0.60 ± 0.10	1.40 ± 0.10	0.40 ± 0.10	0.35 ± 0.10	0.20 ± 0.10	0.10 ± 0.07	0.15 ± 0.10
NRSNE4I2	1.00 ± 0.10	1.20 ± 0.10	0.82 ± 0.05	0.35 ± 0.10	0.43 ± 0.10	0.22 ± 0.10	0.30 ± 0.15
NRSNE4I4	1.00 ± 0.10	2.00 ± 0.10	0.50 ± 0.10	0.45 ± 0.10	0.35 ± 0.10	0.20 ± 0.10	0.35 ± 0.15
NRSNE6I4	1.55 ± 0.10	3.20 ± 0.10	0.80 ± 0.05	0.55 ± 0.10	0.45 ± 0.15	0.20 ± 0.10	0.47 ± 0.15

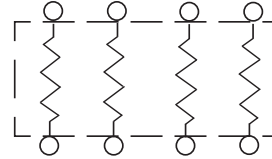


**CIRCUIT SCHEMATICS**

NRSNE2I2, NRSNE4I2  
4 Terminal Isolated

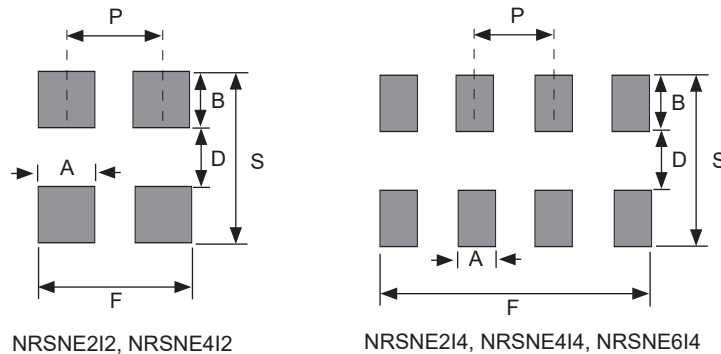


NRSNE2I4, NRSNE4I4, NRSNE6I4  
8 Terminal Isolated



**RECOMMENDED LAND PATTERN DIMENSIONS (mm)**

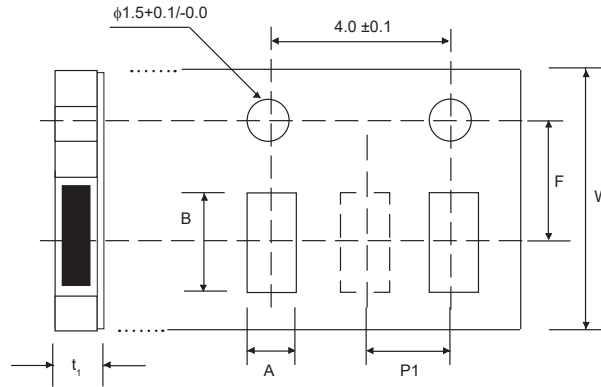
Type	Reflow Soldering					
	A	B	D	P	S	F
NRSNE2I2	0.30	0.30	0.30	0.50	0.90	0.80
NRSNE2I4	0.20	0.30	0.30	0.40	0.90	1.40
NRSNE4I2	0.35	0.45	0.35	0.80	1.25	1.50
NRSNE4I4	0.30	0.65	0.50	0.50	1.80	2.10
NRSNE6I4	0.45	1.03	0.80	0.80	2.85	3.10



**Reflow Soldering Heat Profile and Limits**  
 → [www.niccomp.com/resource/files/resistive/NIC-ChipR-Reflow-Sept2020-Rev2.pdf](http://www.niccomp.com/resource/files/resistive/NIC-ChipR-Reflow-Sept2020-Rev2.pdf)  
 Wave soldering? – Please review your wave soldering process profile with NIC: [tpmg@niccomp.com](mailto:tpmg@niccomp.com)

**TAPE DIMENSIONS (mm)**

Type	Material	A ± 0.10	B ± 0.10	F	p1 ± 0.05	W ± 0.20	t <sub>1</sub> ± 0.10
NRSNE2I2	Paper	0.70	0.90	3.50 ± 0.05	2.00	8.00	0.50
NRSNE2I4		0.70	1.50	3.50 ± 0.05	2.00	8.00	0.50
NRSNE4I2		1.20	1.45	1.75 ± 0.10	2.00	8.00	0.43
NRSNE4I4		1.20	2.20	1.75 ± 0.10	2.00	8.00	0.70
NRSNE6I4		1.95	3.50	1.75 ± 0.10	4.00	8.00	0.85



**REEL DIMENSIONS (mm)**

Type	A	B	C	D	W	Qty/Reel
NRSNE2I2 NRSNE2I4	$\phi 178.5 \pm 0.15$	$\phi 60 -0.0/+1.0$	$\phi 13.0 \pm 0.2$	$\phi 21.0 \pm 0.8$	$9.0 \pm 0.5$	10,000
NRSNE4I2 NRSNE4I4						10,000
NRSNE6I4						5,000

